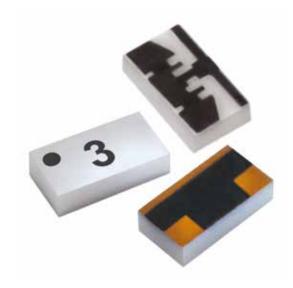
TS06 Series

ATTENUATOR CHIP DC-20GHZ



Smiths Interconnect is the world leader in chip attenuators offering the widest selection of products from DC through Q band. Chip components are offered on Alumina, Aluminum Nitride, Beryllium Oxide, and CVD Diamond for a wide range of applications. Backed by proven performance and significant heritage, Smiths Interconnect is the leader in high reliability components.

The TSO6 platform offers best in class performance from DC-20 GHz in a small package size. Rated for DC-20 GHz with excellent broadband response, the TSO6 series of products has a wide range of applications. It is constructed on an Alumina substrate with rugged thin film terminations and passivated Tantalum Nitride resistive elements. The product also includes a protective coating for added protection from various environmental conditions. Multiple attenuation values and surface finishes are available for RoHS and tin lead solder applications.

TS06 Series Chip Attenuators offers best in class performance from DC-20 GHz in a small package size.

Features and Benefits

- Small Footprint
- Multiple Terminal Finishes
- Broad Frequency Range
- Low VSWR
- Wide Range of Attenuation Values
- Tight Attenuation Tolerance

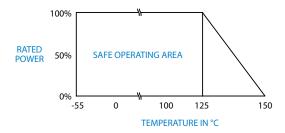
Applications

- Amplifier Circuits
- Transmit/Receive Modules
- Up/Down Converters
- Instrumentation
- Satellite Communications
- Radar
- Broadcast

Technical Characteristics

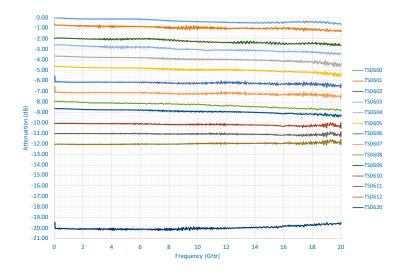
Mounting Configuration Options	Planar								
Electrical									
Nominal Impedance	50 ohms								
Frequency Range	DC -20 GHz								
Attenuation Values Available	0-12, 15 & 20 dB in 1 dB Increments								
Attenuation Accuracy	ATTENUATION ACCURACY (dB)								
		uation e (dB)	10-20	10-20 GHz					
		O Conti				nuity Only			
	1	-9	±	0.50	± 0.	± 0.50			
	10-12,	15 & 20	±	0.75	± 1.00				
Input Power CW									
	dB	Watts	dB	Watts	dB	Watts			
	0-1	3.0	2-3	1.0	10-12, 15 & 20	0.5			
Peak Power	10X CW power based on 1 µS pulse width @ 1% Duty Cycle								
VSWR	DC-10GHz 1.25:1 Max, 10-20GHz 1.35:1 Max								
Environmental									
Operating Temperature	-55°C to +150°C								
Storage Temperature	-65°C to +150°C								
Temperature Coefficient	± 200 PPM/°C Max								
Moisture Sensitivity Level	MSL 1 - Unlimited								
Mechanical									
Substrate Material	Alumina (Al ₂ O ₃) 96%								
Resistive Film	Thin Film, Tantalum Nitride								
Protective Coating	Silicon Nitride								
Finish Options Blank									
-F									
-S									
Marking									
Unit Marking	Orientation dot and dB Value								
Quality Assurance									
	Sample visual ar	d mechanical inspec	ction - 1.0 AQL pe	er mechanical drav	ving requirements.				
	Periodic electrical inspection performed for commerical grade products.								
	High reliability tested products are available per MIL-PRF-55342.								
Packaging									
Standard Packaging	Tape and Reel o	Waffle Pack							

Power Derating Curve



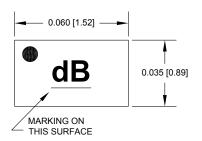
Typical Data

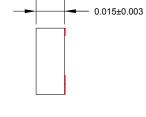
TS06XX Series Attenuation

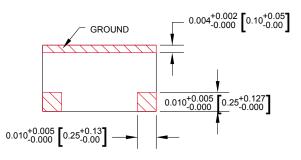


Mechanical

TS06XX Series Attenuation

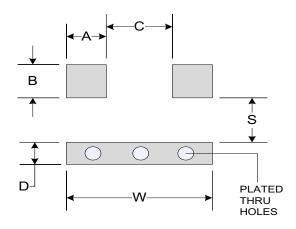






Suggested Mounting Footprint

		Inches				Millimeters						
Part Number	А	В	С	D	S	W	Α	В	С	D	S	W
TS06xxF	0.018	0.018	0.033	0.020	0.016	0.068	0.46	0.46	0.84	0.51	0.41	1.73



How To Order

Specify Model Number: TS06XXX

T S 0 6			
1	2		3
1 Series Name	T S O 6 Series		
2 Attenuation Value	0 0 00 dB through 12.0 dB	1 5 15.0 dB	2 0 20.0 dB
3 Terminal Finish	Standard S Pretinning	F RoHS	

Worldwide Support

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